MICHAEL BELLA

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TECHNICAL STRENGTHS

Programming Languages Embedded C, LabView, Python, C/C++

Software Tools Eclipse, Git, SVN, Code Composer Studio, IAR, Spice, AWR Microwave Office,

CADSoft Eagle, Matlab

Design Experience Low Power Embedded Systems, RF Matching Networks & Amplifiers

Analog Signal Processing, High Precision Analog Measurement, SMPS Design

Lab Skills SMD Soldering, Wiring harness construction, PCA Bringup and Debug

Prototyping, Build designs from print

Other Technical Experience Proficient with Linux, Texas Instruments MSP430 Processor Family

WORK EXPERIENCE

KLA-TencorElectrical Engineer

December 2011 - Present

Milpitas, CA

350°C Calibration System

· Integrated existing high temperature oven with a National Instruments Compact FieldPoint Controller.

- · Developed a state chart for controlling the entire calibration system from the Compact FieldPoint.
- · Tuned cascaded control loops to get the system to each set point.

High Temperature Wireless Wafer

- · Wrote LabView which automatically tests all possible failure modes of a wafer substrate with thin-film aluminum traces.
- · Wrote LabView application to use an Agilent 3490a as a curve tracer to manually diagnose faults in substrates.
- · Designed a lump element model of the inductive wafer charging system in order to implement a simulated wafer communication system.
- · Hand wired prototype of a nanoamp current measurement fixture.
- · Hand wired interface board prototypes to enable the test and calibration of these wafer prototypes.

New Sensorised Wafer Project

- · Modified existing embedded C wafer code base to work with new types of sensors.
 - Reduced project development time from 6 months to 1 month by using with an existing codebase and an existing electrical design.
 - Rewrote measurement subsystem to interface with the new sensor type.
 - Redesigned data-store format to support the new sensor.
 - Rewrote portions of existing manufacturing software to support calibration.
- · Wrote PC software in LabView to launch wafer missions, and to retrieve data from these new sensors.
- · Designed custom data processing software in Python to support data driven development of new sensor platforms.
 - Calibrated the data, and corrected for intrinsic sensor offset
 - Automatically identified features in the data in order to parse it
 - This software reduced the time required to parse one data file from 1-2 hours down to 5 minutes

FOUP Improvments

- · Designed a circuit to recover the wafer communication signal from the envelope detector with improved sensitivity over the existing design.
- · Characterized the improved wafer communication system performance.

KLA-Tencor Internship

June 2005 - December 2011

Milpitas, CA

Electrical Engineer

- \cdot Developed Lab View code for a wide range different projects
 - Automated capacitor tester
 - Wireless communication system tester
 - Synchronous serial link to a custom embedded sensor system
- · Characterized the magnetically coupled wafer communication system
- · Performed PCB diagnostic work, failure analysis, rework of SMD and through hole components.

EDUCATION

San Jose State University

B.S. in Electrical Engineering

December 2011